<u>Onsemí</u>.

MOSFET – N-Channel, UniFET™

300 V, 59 A, 56 m Ω

FDA59N30

Description

UniFET[™] MOSFET is **onsemi**'s high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.

Features

- $R_{DS(on)} = 47 \text{ m}\Omega \text{ (Typ.)} @ V_{GS} = 10 \text{ V}, I_D = 29.5 \text{ A}$
- Low Gate Charge (Typ. 77 nC)
- Low C_{rss} (Typ. 80 pF)
- 100% Avalanche Tested

Applications

- PDP TV
- Uninterruptible Power Supply
- AC-DC Power Supply

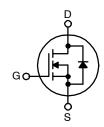
Symbol		Parameter	Value	Unit
V _{DSS}	Drain-Source \	300	V	
۱ _D	Drain Current	– Continuous (T _C = 25°C) – Continuous (T _C = 100°C)	59 35	A A
I _{DM}	Drain Current	 Pulsed (Note 1) 	236	А
V _{GSS}	Gate-Source V	±30	V	
E _{AS}	Single Pulsed A	1734	mJ	
I _{AR}	Avalanche Curr	59	А	
E _{AR}	Repetitive Avala	50	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.5	V/ns
P _D	Power $(T_C = 25^{\circ}C)$ Dissipation- Derate Above $25^{\circ}C$		500 4	W W/°C
T _{J,} T _{STG}	Operating and \$	–55 to +150	°C	
ΤL	Maximum Lead 1/8" from Case	300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



TO-3P-3LD / EIAJ SC-65, ISOLATED CASE 340BZ

N-CHANNEL MOSFET



MARKING DIAGRAM



FDA59N30	= Specific Device Code
A	= Assembly Location
YWW	= Date Code (Year and Week)
ZZ	= Assembly Lot

ORDERING INFORMATION

Device	Package	Shipping
FDA59N30	TO-3P-3L (Pb-Free)	450 Units / Tube

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.25	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	40	°C/W

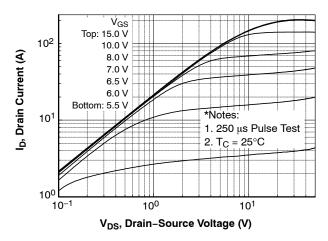
ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
OFF CHAF	ACTERISTICS					-
BV_DSS	Drain-Source Breakdown Voltage	V_{GS} = 0 V, I_D = 250 μA	300	-	-	V
$\begin{array}{c} \Delta \text{BV}_{\text{DSS}} \\ / \ \Delta \text{T}_{\text{J}} \end{array}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C	-	0.3	_	V/∘C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 300 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 240 \text{ V}, T_{C} = 125^{\circ}\text{C}$	-		1 10	μΑ μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = 30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	-	-	100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V_{GS} = -30 V, V_{DS} = 0V	-	-	-100	nA
ON CHAR	ACTERISTICS					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	3.0	-	5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 29.5 A	-	0.047	0.056	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 40 V, I _D = 29.5 A	-	52	-	S
DYNAMIC	CHARACTERISTICS					
C _{iss}	Input Capacitance	V_{DS} = 25 V, V_{GS} = 0 V, f = 1 MHz	-	3590	4670	pF
C _{oss}	Output Capacitance		-	710	920	pF
C _{rss}	Reverse Transfer Capacitance		-	80	120	pF
SWITCHIN	G CHARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 150 \text{ V}, \text{ I}_{D} = 59 \text{ A},$	-	140	290	ns
t _r	Turn-On Rise Time	V_{GS}^{-} = 10 V, R_{G}^{-} = 25 Ω (Note 4)	-	575	1160	ns
t _{d(off)}	Turn-Off Delay Time		-	120	250	ns
t _f	Turn-Off Fall Time		-	200	410	ns
Qg	Total Gate Charge	V _{DS} = 240 V, I _D = 59 A, V _{GS} = 10 V (Note 4)	-	77	100	nC
Q _{gs}	Gate-Source Charge		-	22	-	nC
Q _{gd}	Gate-Drain Charge]	-	40	-	nC
DRAIN-SC	DURCE DIODE CHARACTERISTICS AND MAX	(IMUM RATINGS				
۱ _S	Maximum Continuous Drain-Source Diode Fo	rward Current	-	-	59	Α

IS	Maximum Continuous Drain-Source Diode Forward Current		-	-	59	A
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		-	-	236	А
V_{SD}	rain–Source Diode Forward Voltage $V_{GS} = 0 V$, $I_S = 59 A$		-	-	1.4	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 V, I_S = 59 A,$	-	246	-	ns
Q _{rr}	Reverse Recovery Charge	dI _F /dt = 100 A/μs	-	6.9	-	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions performance may not be indicated by the Electrical Characteristics if operated under different conditions. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. L = 0.83 mH, I_{AS} = 59 A, V_{DD} = 50 V, R_G = 25 Ω , starting T_J = 25°C. 3. I_{SD} ≤ 59 A, di/dt ≤ 200 A/µs, V_{DD} ≤ BV_{DSS}, starting T_J = 25°C. 4. Essentially independent of operating temperature typical characteristics.

TYPICAL PERFORMANCE CHARACTERISTICS





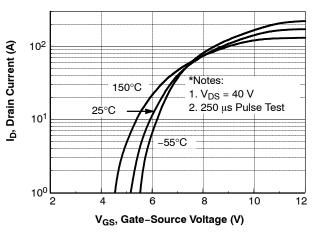


Figure 2. Transfer Characteristics

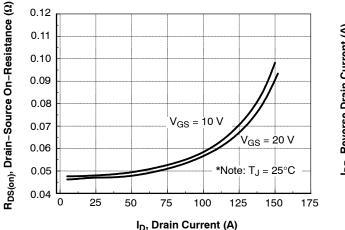


Figure 3. On–Resistance Variation vs. Drain Current and Gate Voltage

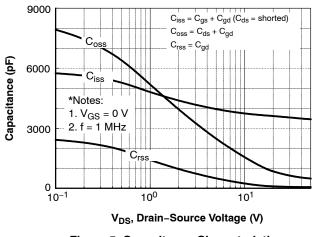


Figure 5. Capacitance Characteristics

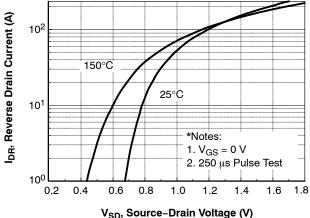


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

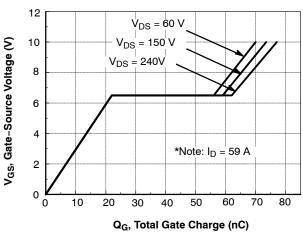
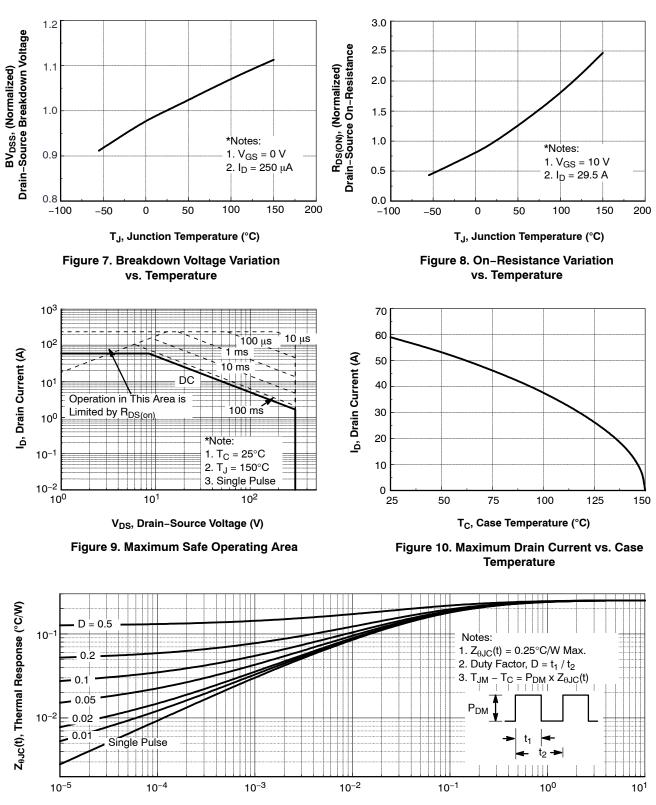


Figure 6. Gate Charge Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (continued)



t₁, Rectangular Pulse Duration (s)

Figure 11. Transient Thermal Response Curve

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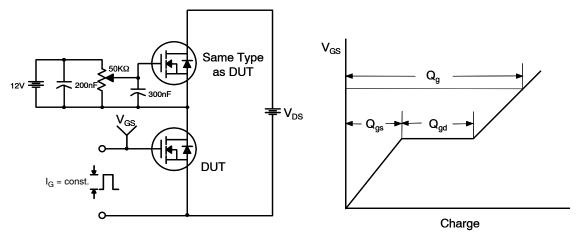


Figure 12. Gate Charge Test Circuit & Waveform

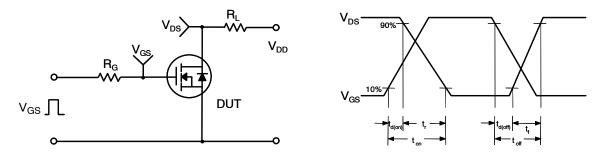


Figure 13. Resistive Switching Test Circuit & Waveforms

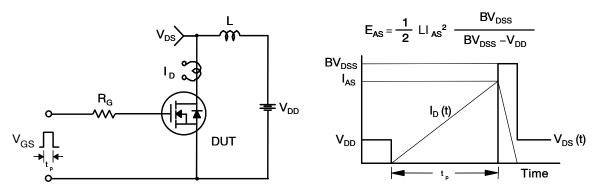


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

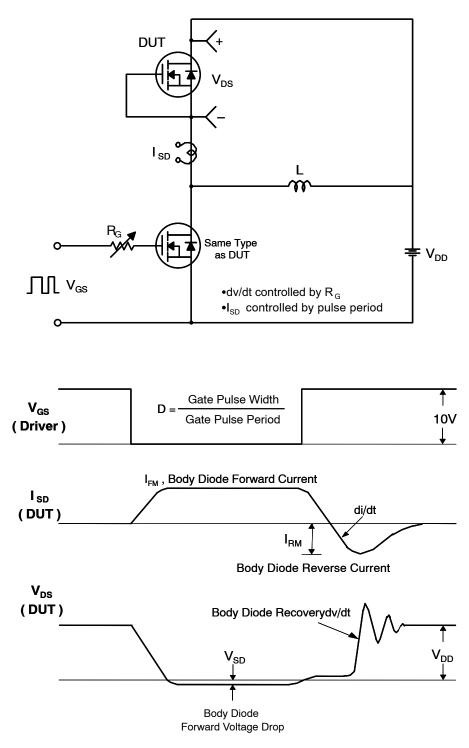
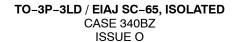


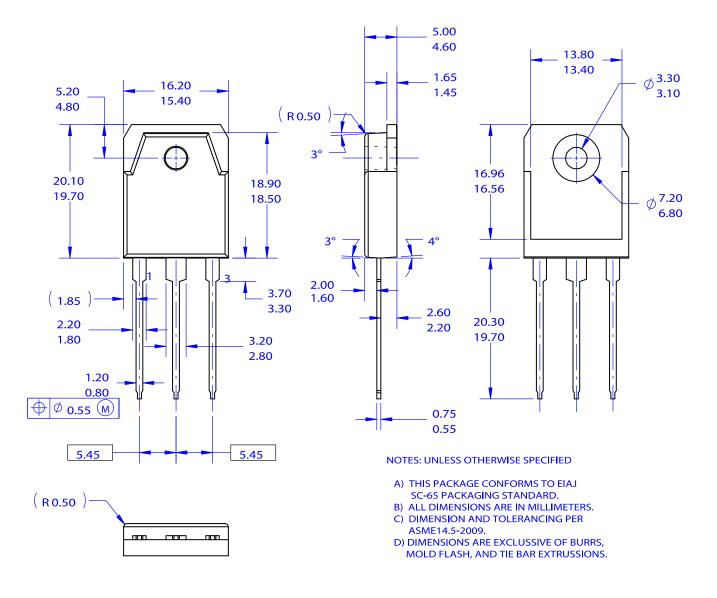
Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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